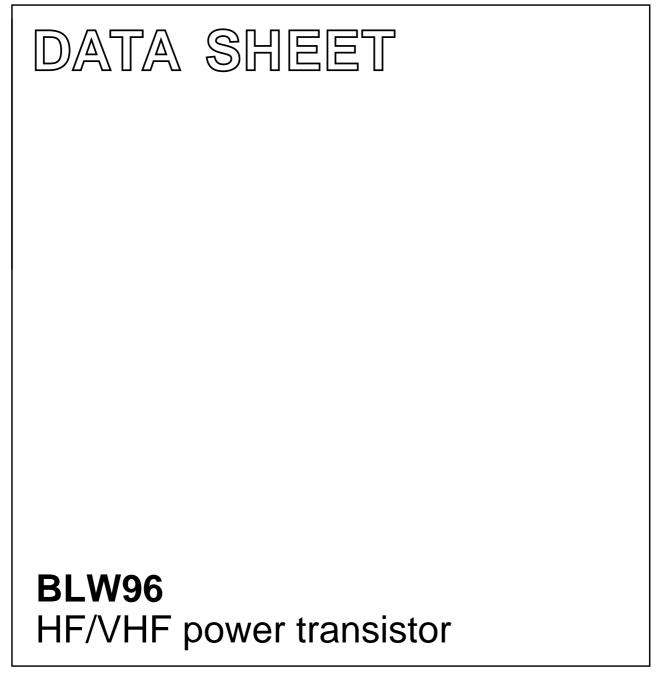
DISCRETE SEMICONDUCTORS



Product specification

August 1986



HILIPS

DESCRIPTION

N-P-N silicon planar epitaxial transistor intended for use in class-A, AB and B operated high power industrial and military transmitting equipment in the h.f. and v.h.f. band. The transistor presents excellent performance as a linear amplifier in s.s.b. applications. It is resistance stabilized and is guaranteed to withstand severe load mismatch conditions. Transistors are supplied in matched h_{FE} groups.

The transistor has a $\frac{1}{2}$ " flange envelope with a ceramic cap. All leads are isolated from the flange.

QUICK REFERENCE DATA

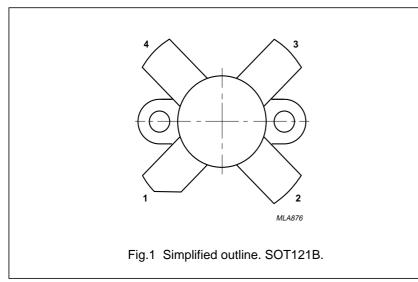
R.F. performance up to $T_h = 25 \ ^{\circ}C$

MODE OF OPERATION	V _{CE} V	f MHz	PL W	G _p dB	-	ղ %		d ₃ IB		d₅ dB	I _{C(ZS)} (I _C) A
s.s.b. (class-AB)	50	1,6 – 28	25 – 200 (P.E.P.)	> '	13,5	> 40 ⁽¹⁾	<	-30	<	-30	0,1
c.w. (class-B)	50	108	200	typ.	6,5	typ. 67		_		-	(6)
s.s.b. (class-A)	40	28	50 (P.E.P.)	typ.	19	_	typ.	-40	<	-40	(4)

Note

1. η_{dt} at 200 W P.E.P.

PIN CONFIGURATION



PINNING - SOT121B.

PIN	DESCRIPTION		
1	collector		
2	emitter		
3	base		
4	emitter		

PRODUCT SAFETY This device incorporates beryllium oxide, the dust of which is toxic. The device is entirely safe provided that the BeO disc is not damaged.

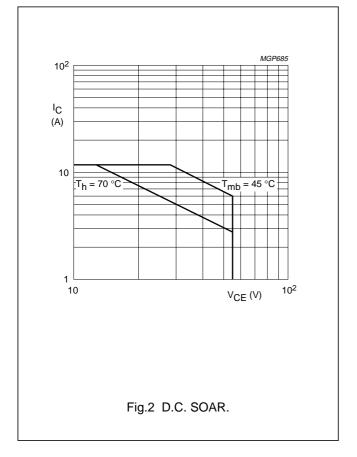
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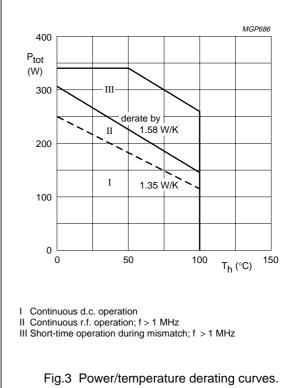
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RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Collector-emitter voltage ($V_{BE} = 0$)		
peak value	V _{CESM}	max. 110 V
Collector-emitter voltage (open base)	V _{CEO}	max. 55 V
Emitter-base voltage (open collector)	V _{EBO}	max. 4 V
Collector current (average)	I _{C(AV)}	max. 12 A
Collector current (peak value); f > 1 MHz	I _{CM}	max. 40 A
R.F. power dissipation (f > 1 MHz); T_{mb} = 45 °C	P _{rf}	max. 340 W
Storage temperature	T _{stg}	-65 to + 150 °C
Operating junction temperature	Тj	max. 200 °C





THERMAL RESISTANCE

(dissipation = 150 W; T_{mb} = 100 °C, i.e. T_{h} = 70 °C)

From junction to mounting base (d.c. dissipation) From junction to mounting base (r.f. dissipation) From mounting base to heatsink

R _{th j-mb(dc)}	=	0,63 K/W
R _{th j-mb(rf)}	=	0,45 K/W
R _{th mb-h}	=	0,2 K/W

CHARACTERISTICS

HF/VHF power transistor

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$T_j = 25 \text{ °C}$				
Collector-emitter breakdown voltage				
$V_{BE} = 0; I_{C} = 50 \text{ mA}$	V _{(BR)CES}	>	110	V
Collector-emitter breakdown voltage	. ,			
open base; I _C = 200 mA	V _{(BR)CEO}	>	55	V
Emitter-base breakdown voltage				
open collector; I _E = 20 mA	V _{(BR)EBO}	>	4	V
Collector cut-off current				
V _{BE} = 0; V _{CE} = 55 V	I _{CES}	<	10	mA
Second breakdown energy; L = 25 mH; f = 50 Hz				
open base	E _{SBO}	>	20	mJ
R _{BE} = 10 Ω	E _{SBR}	>	20	mJ
D.C. current gain ⁽¹⁾				
$I_{C} = 7 \text{ A}; V_{CE} = 5 \text{ V}$	h _{FE}	typ. 15 to	30 50	
D.C. current gain ratio of matched devices ⁽¹⁾				
$I_{C} = 7 \text{ A}; V_{CE} = 5 \text{ V}$	h _{FE1} /h _{FE2}	\leq	1,2	
Collector-emitter saturation voltage ⁽¹⁾				
$I_{\rm C} = 20$ A; $I_{\rm B} = 4$ A	V _{CEsat}	typ.	1,9	V
Transition frequency at $f = 100 \text{ MHz}^{(2)}$				
$-I_{E} = 7 \text{ A}; V_{CB} = 45 \text{ V}$	f _T	typ.	235	MHz
–I _E = 20 A; V _{CB} = 45 V	f _T	typ.	245	MHz
Collector capacitance at f = 1 MHz				
$I_{E} = I_{e} = 0; V_{CB} = 50 V$				
Feedback capacitance at f = 1 MHz	C _c	typ.	280	pF
I _C = 150 mA; V _{CE} = 50 V	C _{re}	typ.	170	pF
Collecting-flange capacitance	C _{cf}	typ.	4,4	pF

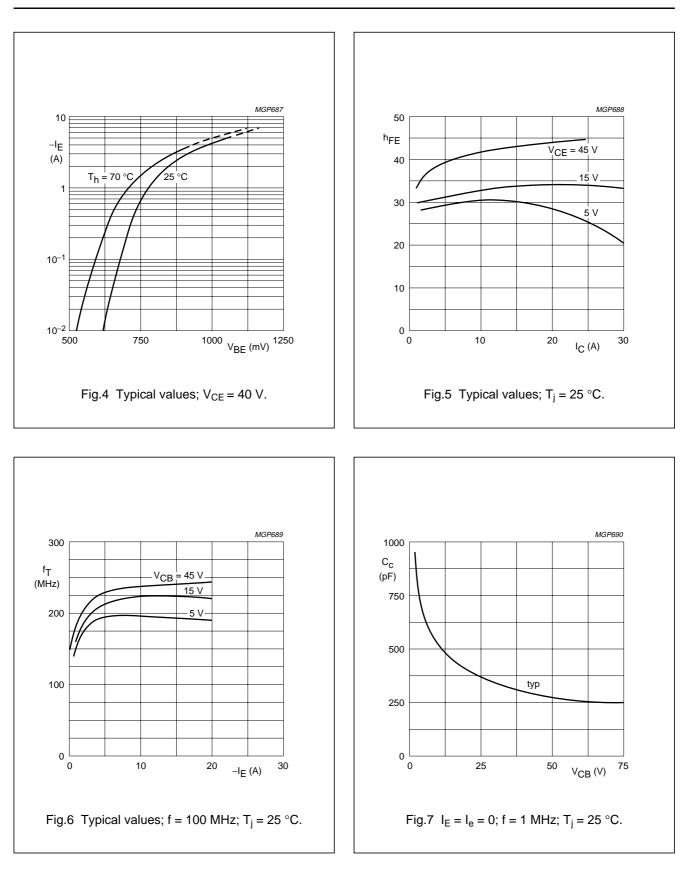
Notes

1. Measured under pulse conditions: $t_p \leq 300 \ \mu s; \ \delta \leq 0,02.$

2. Measured under pulse conditions: $t_p \leq ~50~\mu s; ~\delta \leq 0,01.$

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HF/VHF power transistor

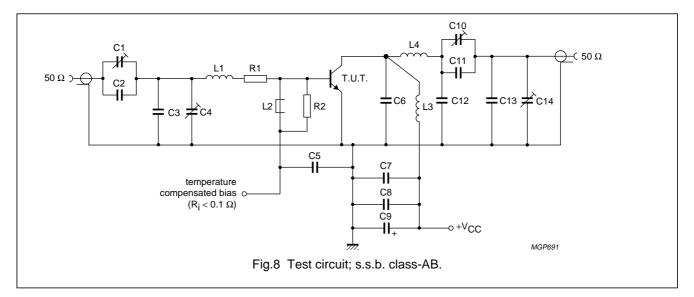


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APPLICATION INFORMATION

R.F. performance in s.s.b. class-AB operation (linear power amplifier) V_{CE} = 50 V; T_h = 25 °C; f₁ = 28,000 MHz; f₂ = 28,001 MHz

OUTPUT POWER	Gp	ղ _{dt} (%)	I _C (A)	d ₃ ⁽¹⁾	d 5 ⁽¹⁾	I _{C(ZS)}
W	dB	at 200 W	(P.E.P.)	dB	dB	Α
25 to 200 (P.E.P.)	> 13,5	> 40	< 5,0	< -30	< -30	0,1



List of components:

- C1 = C4 = C10 = C14 = 100 pF film dielectric trimmer
- C2 = 27 pF ceramic capacitor (500 V)
- C3 = 270 pF polysterene capacitor (630 V)
- C5 = C7 = C8 = 220 nF multilayer ceramic chip capacitor
- C6 = 27 pF multilayer ceramic chip capacitor (500 V; ATC⁽²⁾)
- C9 = 47 μ F/63 V electrolytic capacitor

C11 = 2×36 pF multilayer ceramic chip capacitors (500 V; ATC⁽²⁾) in parallel

C12 = 2×43 pF multilayer ceramic chip capacitors (500 V; ATC⁽²⁾) in parallel

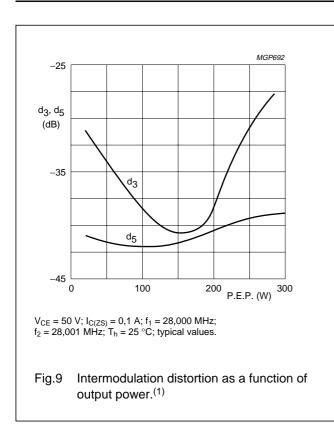
- C13 = 43 pF multilayer ceramic chip capacitor (500 V; $ATC^{(2)}$)
- L1 = 88 nH; 3 turns Cu wire (1,0 mm); int. dia. 9,0 mm; length 6,1 mm; leads 2×5 mm
- L2 = Ferroxcube wide-band h.f. choke, grade 3B (cat. no. 4312 020 36640)
- L3 = 150 nH; 5 turns Cu wire (2,0 mm); int. dia. 10,0 mm; length 18,7 mm; leads 2×5 mm
- L4 = 197 nH; 5 turns Cu wire (2,0 mm); int. dia. 12,0 mm; length 18,6 mm; leads 2×5 mm
- R1 = 0,66 Ω ; parallel connection of 5 × 3,3 Ω metal film resistors (PR37; ± 5%; 1,6 W each)
- R2 = 27 Ω carbon resistor (± 5%; 0,5 W)

Notes

- 1. Stated intermodulation distortion figures are referred to the according level of either of the equal amplified tones. Relative to the according peak envelope powers these figures should be increased by 6 dB.
- 2. ATC means American Technical Ceramics.

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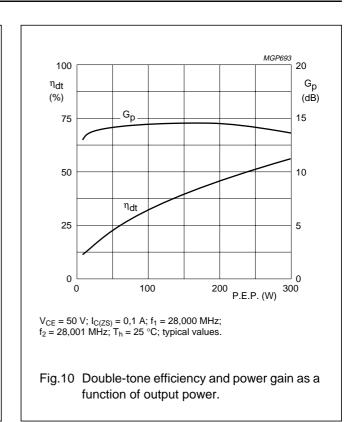
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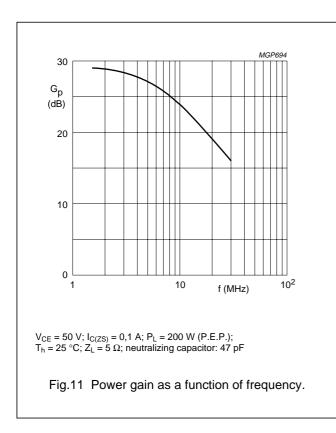
Ruggedness

The BLW96 is capable of withstanding full load mismatch (VSWR = 50 through all phases) up to 150 W (P.E.P.) or a load mismatch (VSWR = 5 through all phases) up to 200 W (P.E.P.) under the following conditions:

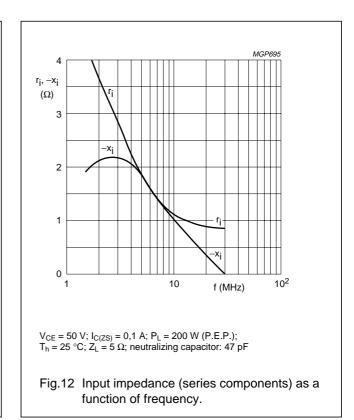
 V_{CE} = 45 V; f = 28 MHz; T_{h} = 70 °C; $R_{th\ mb-h}$ = 0,2 K/W.



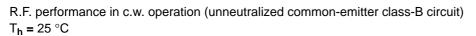
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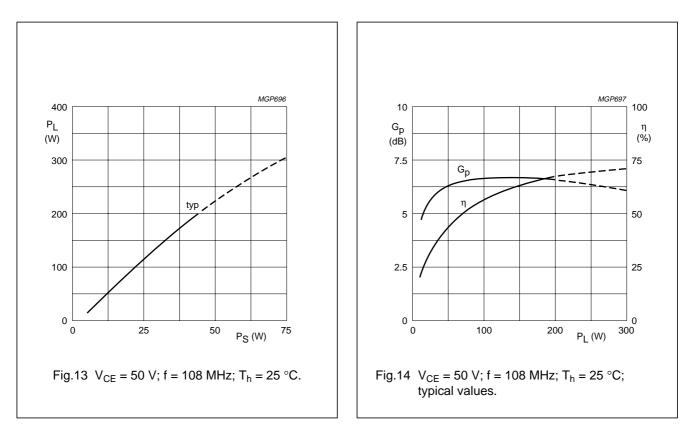
Figs 11 and 12 are typical curves and hold for one transistor of a push-pull amplifier with cross-neutralization in s.s.b. class-AB operation.



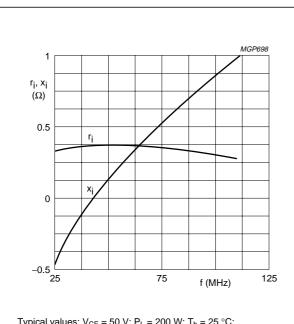
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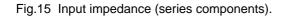
f (MHz)	V _{CE} (V)	P _L (W)	P _S (W)	G _p (dB)	I _C (A)	η (%)
108	50	200	typ. 45	typ. 6,5	typ. 6	typ. 67

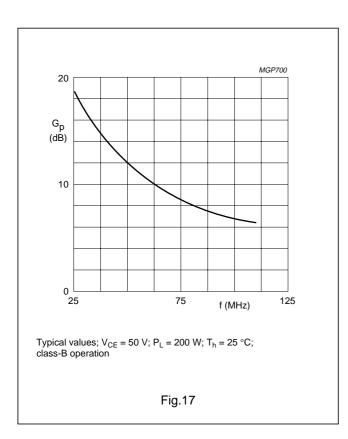


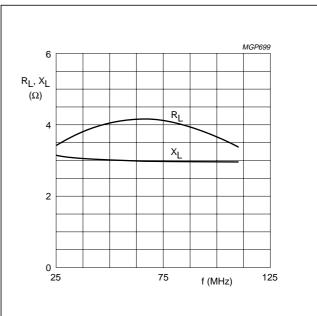
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Typical values; V_{CE} = 50 V; P_L = 200 W; T_h = 25 °C; class-B operation







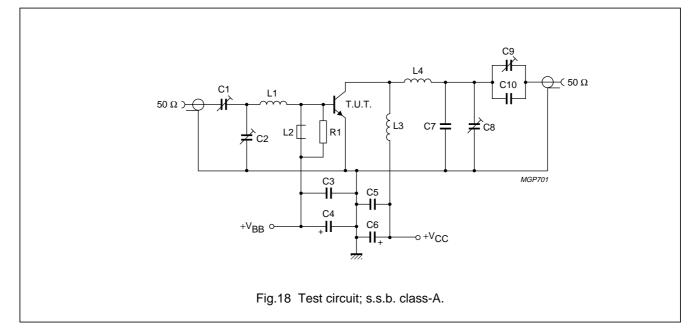
Typical values; V_CE = 50 V; P_L = 200 W; T_h = 25 $^\circ\text{C};$ class-B operation

Fig.16 Load impedance (series components).

BLW96

R.F. performance in s.s.b. class-A operation (linear power amplifier) V_{CE} = 40 V; T_h = 25 °C; f₁ = 28,000 MHz; f₂ = 28,001 MHz

OUTPUT POWER	G _p	l _C	d ₃ ⁽¹⁾	d ₅ ⁽¹⁾
W	dB	A	dB	dB
typ. 50 (P.E.P.)	typ. 19	4	typ. –40	< -40

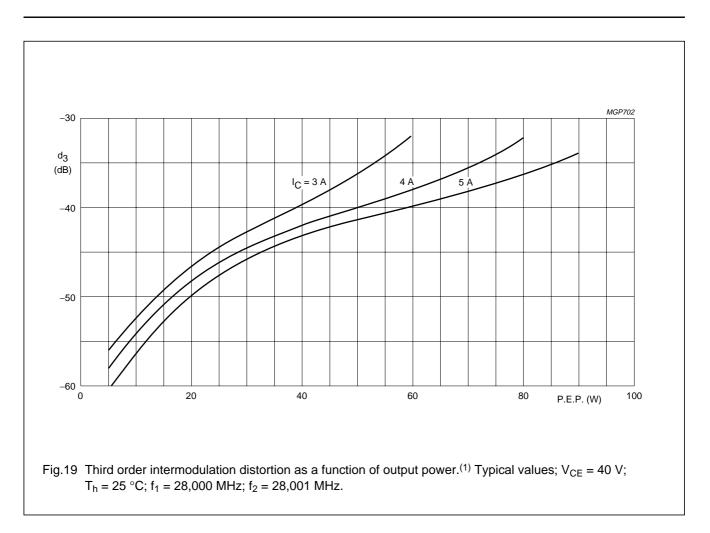


List of components:

- C1 = C2 = 10 to 780 pF film dielectric trimmer
- C3 = 220 nF polyester capacitor (100 V)
- $C4 = 100 \ \mu F/4 \ V$ electrolytic capacitor
- $C5 = 2 \times 330 \text{ nF}$ polyester capacitors (100 V) in parallel
- C6 = 47 μ F/63 V electrolytic capacitor
- $C7 = C10 = 2 \times 82 \text{ pF}$ ceramic capacitors (500 V) in parallel
- C8 = C9 = 10 to 150 pF air dielectric trimmer
- L1 = 45 nH; 2 turns enamelled Cu wire (1,6 mm); int. dia. 8,0 mm; length 4,0 mm; leads 2 × 3 mm
- L2 = Ferroxcube wide-band h.f. choke, grade 3B (cat. no. 4312 020 36640)
- L3 = 110 nH; 4 turns enamelled Cu wire (2,0 mm); int. dia. 10,0 mm; length 8,0 mm; leads 2 × 2 mm
- L4 = 210 nH; 5 turns enamelled Cu wire (2,0 mm); int. dia. 12,0 mm; length 10,0 mm; leads 2 × 2 mm
- R1 = 27 Ω carbon resistor (± 5%; 0,5 W)

Note

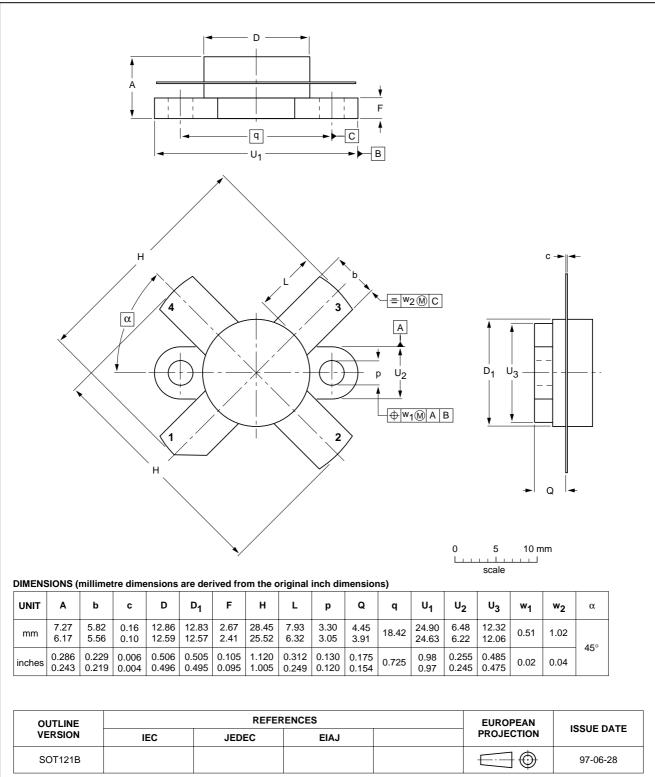
1. Stated intermodulation distortion figures are referred to the according level of either of the equal amplified tones. Relative to the according peak envelope powers these figures should be increased by 6 dB.



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PACKAGE OUTLINE

Flanged ceramic package; 2 mounting holes; 4 leads



BLW96

SOT121B

BLW96

DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
more of the limiting values r of the device at these or at a	accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or nay cause permanent damage to the device. These are stress ratings only and operation any other conditions above those given in the Characteristics sections of the specification imiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.